

# 74ALVC16245; 74ALVCH16245

16-bit transceiver with direction pin; 3-state

Rev. 4 — 21 November 2017

Product data sheet

## 1 General description

The 74ALVC16245; 74ALVCH16245 is a 16-bit transceiver featuring non-inverting 3-state bus compatible outputs in both send and receive directions.

The 74ALVC16245; 74ALVCH16245 features two output enable inputs (pins  $\overline{nOE}$ ) for easy cascading and two send or receive inputs (pins  $nDIR$ ) for direction control. Pins  $\overline{nOE}$  control the outputs so that the buses are effectively isolated. This device can be used as two 8-bit transceivers or one 16-bit transceiver.

The 74ALVCH16245 has an active bushold circuitry which is provided to hold unused or floating data inputs at a valid logic level. This feature eliminates the need for external pull-up or pull-down resistors.

## 2 Features and benefits

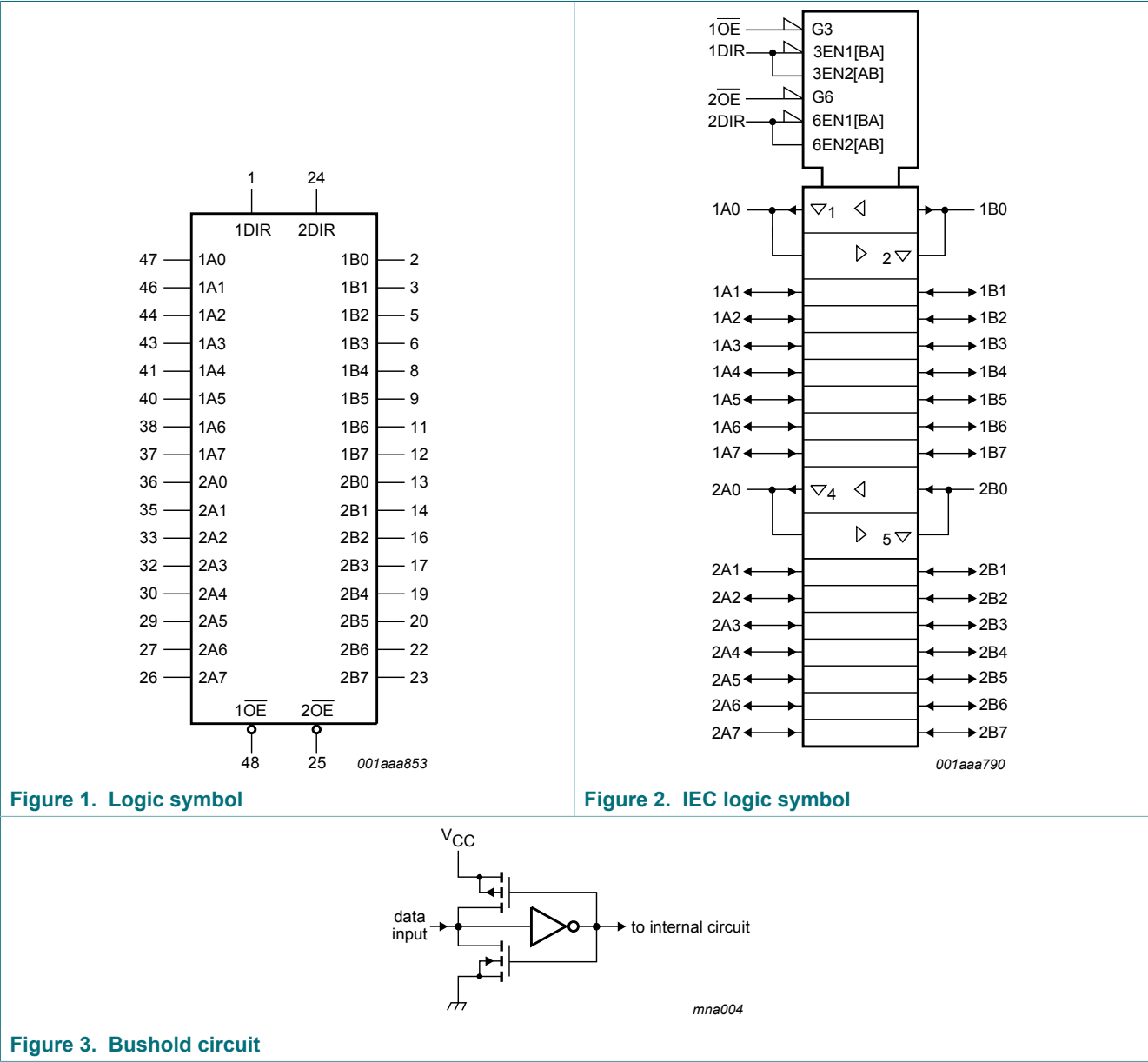
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple  $V_{CC}$  and GND pins for minimize noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bushold (74ALVCH16245 only)
- Output drive capability 50  $\Omega$  transmission lines at 85 °C
- Current drive  $\pm 24$  mA at  $V_{CC} = 3.0$  V.
- Complies with JEDEC standards:
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM ANSI/ESDA/JEDEC JS-001 exceeds 2000 V
  - CDM JESD22-C101E exceeds 1000 V

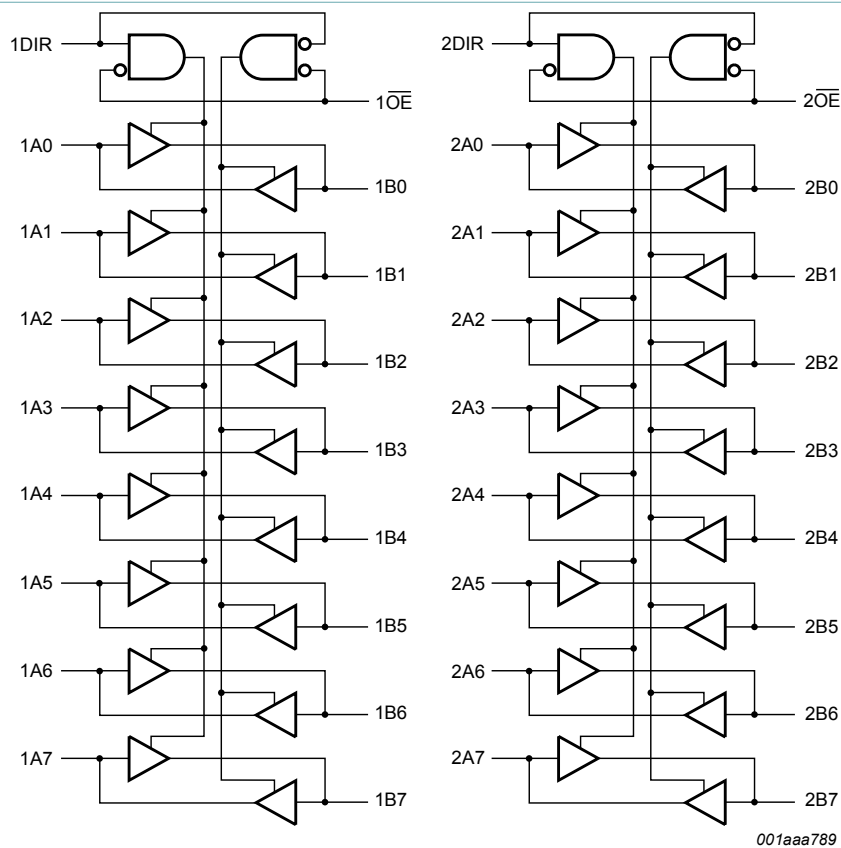
## 3 Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74ALVC16245DL	-40 °C to +85 °C	SSOP48	plastic shrink small outline package; 48 leads; body width 7.5 mm	SOT370-1
74ALVCH16245DL				
74ALVC16245DGG	-40 °C to +85 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1
74ALVCH16245DGG				

4 Functional diagram





**Figure 4. Logic diagram**

5 Pinning information

5.1 Pinning

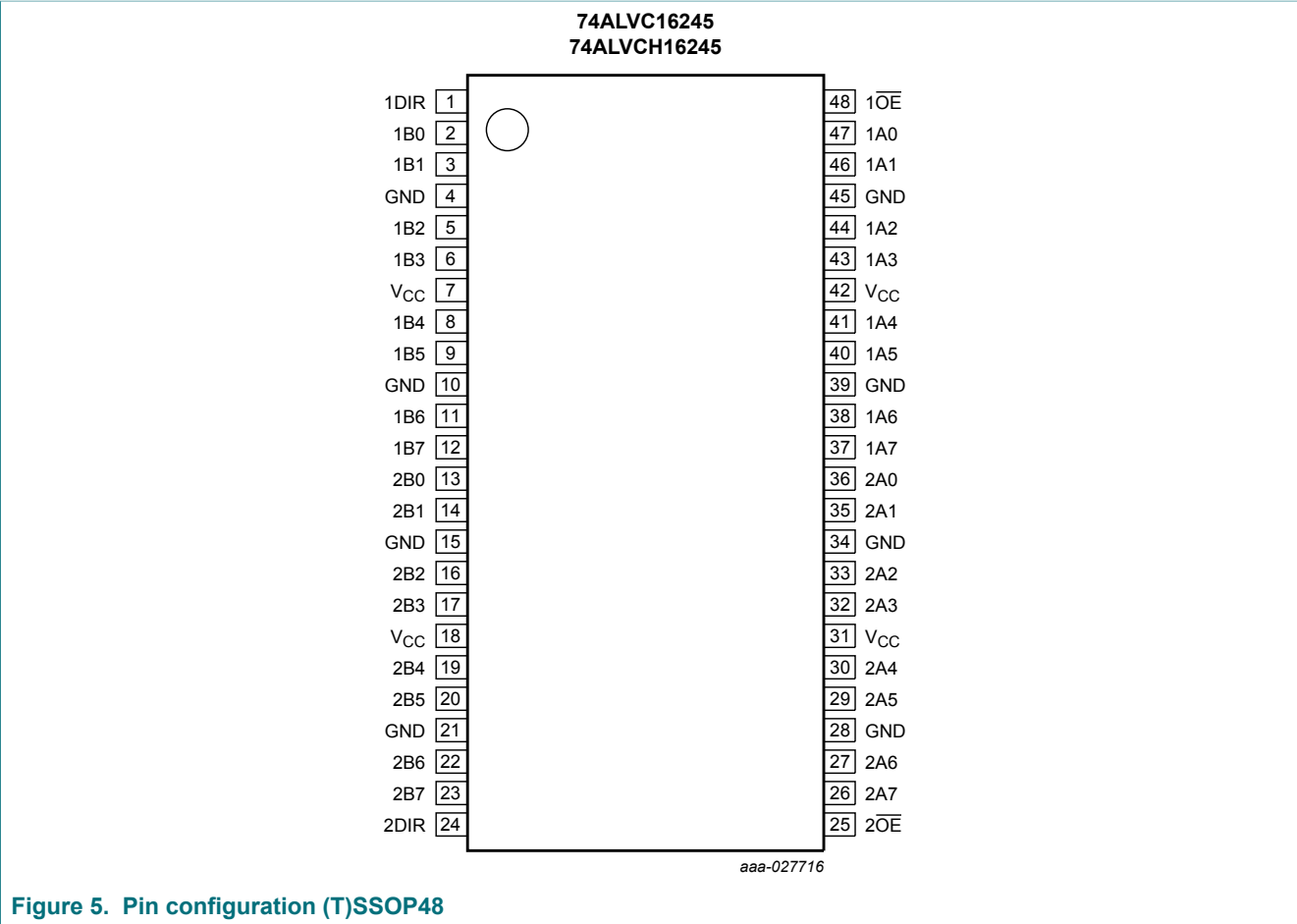


Figure 5. Pin configuration (T)SSOP48

5.2 Pin description

Table 2. Pin description

Pin	Symbol	Description
1, 24	1DIR, 2DIR	direction control inputs
2, 3, 5, 6, 8, 9, 11, 12	1B0, 1B1, 1B2, 1B3, 1B4, 1B5, 1B6, 1B7	data output or input
4, 10, 15, 21, 28, 34, 39, 45	GND	ground (0 V)
7, 18, 31, 42	V <sub>CC</sub>	positive supply voltage
13, 14, 16, 17, 19, 20, 22, 23	2B0, 2B1, 2B2, 2B3, 2B4, 2B5, 2B6, 2B7	data output or input
48, 25	1OE, 2OE	output enable input (active LOW)
36, 35, 33, 32, 30, 29, 27, 26	2A0, 2A1, 2A2, 2A3, 2A4, 2A5, 2A6, 2A7	data input or output
47, 46, 44, 43, 41, 40, 38, 37	1A0, 1A1, 1A2, 1A3, 1A4, 1A5, 1A6, 1A7	data input or output

## 6 Functional description

Table 3. Function table <sup>[1]</sup>

Input		Input or output	
nOE	nDIR	nAn	nBn
L	L	output nAn = nBn	input
L	H	input	output nBn = nAn
H	X	Z	Z

[1] H = HIGH voltage level  
 L = LOW voltage level  
 X = don't care  
 Z = high-impedance OFF-state.

## 7 Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
V <sub>I</sub>	input voltage	data inputs with bushold <sup>[1]</sup>	-0.5	V <sub>CC</sub> + 0.5	V
		data inputs without bushold <sup>[1]</sup>	-0.5	+4.6	V
		control pins <sup>[1]</sup>	-0.5	+4.6	V
V <sub>O</sub>	output voltage	<sup>[1]</sup>	-0.5	V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> > V <sub>CC</sub> or V <sub>O</sub> < 0 V	-	±50	mA
I <sub>O</sub>	output current	V <sub>O</sub> = 0 V to V <sub>CC</sub>	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +85 °C			
		SSOP package <sup>[2]</sup>	-	850	mW
		TSSOP package <sup>[3]</sup>	-	600	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] Above 55 °C the value of P<sub>tot</sub> derates linearly with 11.3 mW/K.

[3] Above 55 °C the value of P<sub>tot</sub> derates linearly with 8 mW/K.

## 8 Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>CC</sub>	supply voltage	maximum speed performance				
		C <sub>L</sub> = 30 pF	2.3	-	2.7	V
		C <sub>L</sub> = 50 pF	3.0	-	3.6	V
		low-voltage applications	1.2	-	3.6	V
V <sub>I</sub>	input voltage		0	-	V <sub>CC</sub>	V
V <sub>O</sub>	output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+85	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.3 V to 3.0 V	-	-	20	ns/V
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	10	ns/V

## 9 Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ <sup>[1]</sup>	Max	Unit
T <sub>amb</sub> = -40 °C to +85 °C						
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	1.2	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	1.5	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	-	1.2	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	1.5	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 2.3 V to 3.6 V	V <sub>CC</sub> - 0.2	V <sub>CC</sub>	-	V
		I <sub>O</sub> = -6 mA; V <sub>CC</sub> = 2.3 V	V <sub>CC</sub> - 0.3	V <sub>CC</sub> - 0.08	-	V
		I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.3 V	V <sub>CC</sub> - 0.6	V <sub>CC</sub> - 0.26	-	V
		I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V	V <sub>CC</sub> - 0.5	V <sub>CC</sub> - 0.14	-	V
		I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 3.0 V	V <sub>CC</sub> - 0.6	V <sub>CC</sub> - 0.09	-	V
		I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V	V <sub>CC</sub> - 1.0	V <sub>CC</sub> - 0.28	-	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 2.3 V to 3.6 V	-	GND	0.20	V
		I <sub>O</sub> = 6 mA; V <sub>CC</sub> = 2.3 V	-	0.07	0.40	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.3 V	-	0.15	0.70	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V	-	0.14	0.40	V
		I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V	-	0.27	0.55	V
I <sub>I</sub>	input leakage current	V <sub>CC</sub> = 2.3 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND	-	0.1	5	μA
I <sub>OZ</sub>	OFF-state output current	V <sub>CC</sub> = 2.3 V to 3.6 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = V <sub>CC</sub> or GND	-	0.1	10	μA

Symbol	Parameter	Conditions	Min	Typ <sup>[1]</sup>	Max	Unit
$I_{CC}$	supply current	$V_{CC} = 2.3\text{ V to }3.6\text{ V}$ ; $V_I = V_{CC}$ or GND; $I_O = 0\text{ A}$	-	0.2	40	$\mu\text{A}$
$\Delta I_{CC}$	additional supply current	74ALVCH16245; per data I/O pin; $V_{CC} = 2.3\text{ V to }3.6\text{ V}$ ; $V_I = V_{CC} - 0.6\text{ V}$ ; $I_O = 0\text{ A}$	-	150	750	$\mu\text{A}$
$I_{BHL}$	bus hold LOW current	$V_{CC} = 2.3\text{ V}$ ; $V_I = 0.7\text{ V}$ <sup>[2]</sup>	45	-	-	$\mu\text{A}$
		$V_{CC} = 3.0\text{ V}$ ; $V_I = 0.8\text{ V}$ <sup>[2]</sup>	75	150	-	$\mu\text{A}$
$I_{BHH}$	bus hold HIGH current	$V_{CC} = 2.3\text{ V}$ ; $V_I = 1.7\text{ V}$ <sup>[2]</sup>	-45	-	-	$\mu\text{A}$
		$V_{CC} = 3.0\text{ V}$ ; $V_I = 2.0\text{ V}$ <sup>[2]</sup>	-75	-175	-	$\mu\text{A}$
$I_{BHLO}$	bus hold LOW overdrive current	$V_{CC} = 3.6\text{ V}$ <sup>[2]</sup>	500	-	-	$\mu\text{A}$
$I_{BHHO}$	bus hold HIGH overdrive current	$V_{CC} = 3.6\text{ V}$ <sup>[2]</sup>	-500	-	-	$\mu\text{A}$
$C_I$	input capacitance		-	4.0	-	pF
$C_{I/O}$	input/output capacitance		-	8.0	-	pF

[1] All typical values are measured at  $T_{amb} = 25\text{ }^{\circ}\text{C}$ .

[2] Valid for data inputs of bushold parts.

## 10 Dynamic characteristics

**Table 7. Dynamic characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 8](#).

Symbol	Parameter	Conditions	Min	Typ <sup>[1]</sup>	Max	Unit
<b>T<sub>amb</sub> = -40 °C to +85 °C</b>						
t <sub>pd</sub>	propagation delay	nAn to nBn; nBn to nAn; see <a href="#">Figure 6</a> <sup>[2]</sup>				
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	2.0	3.7	ns
		V <sub>CC</sub> = 2.7 V	1.0	2.1	3.6	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	1.9	3.0	ns
t <sub>en</sub>	enable time	n $\overline{\text{OE}}$ to nAn; n $\overline{\text{OE}}$ to nBn; see <a href="#">Figure 7</a> <sup>[3]</sup>				
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	2.7	5.7	ns
		V <sub>CC</sub> = 2.7 V	1.0	3.0	5.4	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.3	4.4	ns
t <sub>dis</sub>	disable time	n $\overline{\text{OE}}$ to nAn; n $\overline{\text{OE}}$ to nBn; see <a href="#">Figure 7</a> <sup>[4]</sup>				
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	2.2	5.2	ns
		V <sub>CC</sub> = 2.7 V	1.0	3.1	4.6	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.8	4.1	ns
C <sub>PD</sub>	power dissipation capacitance	per buffer; V <sub>I</sub> = GND to V <sub>CC</sub> <sup>[5]</sup>				
		outputs enabled	-	29	-	pF
		outputs disabled	-	5	-	pF

[1] Typical values are measured at T<sub>amb</sub> = 25 °C

Typical values for V<sub>CC</sub> = 2.3 V to 2.7 V are measured at V<sub>CC</sub> = 2.5 V.

Typical values for V<sub>CC</sub> = 3.0 V to 3.6 V are measured at V<sub>CC</sub> = 3.3 V.

[2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

[3] t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>.

[4] t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>.

[5] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu\text{W}$ ).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in Volts;

N = total load switching outputs;

$\sum (C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.



10.1 Waveforms and test circuit

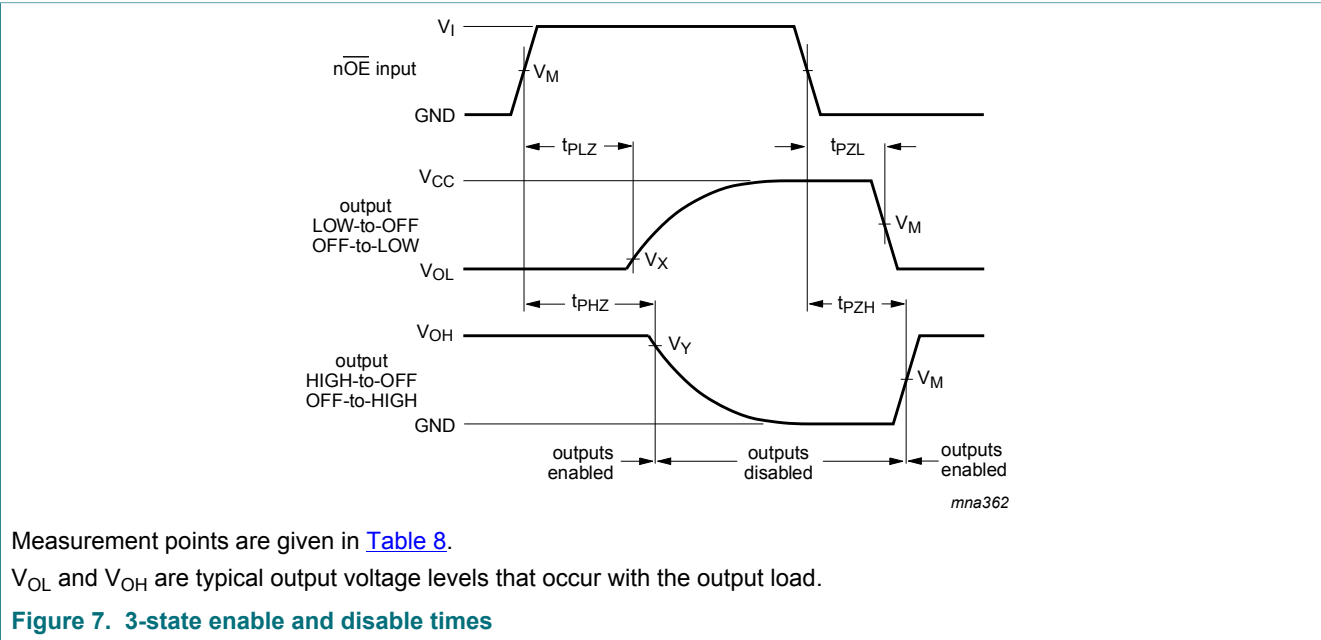
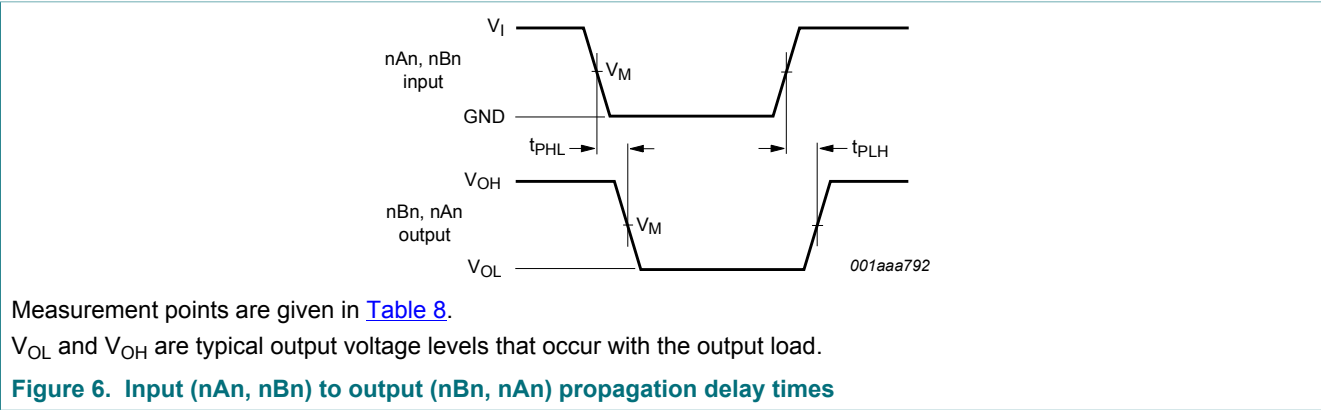
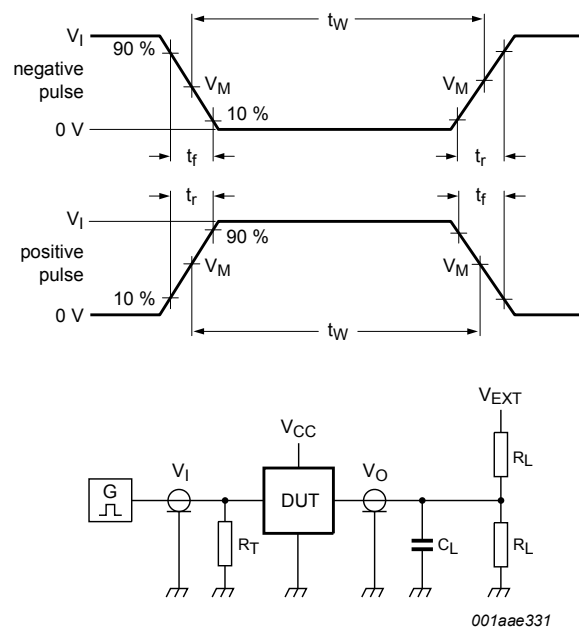


Table 8. Measurement points

Supply voltage	Input	Output		
$V_{CC}$	$V_M$	$V_M$	$V_X$	$V_Y$
$< 2.7\text{ V}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15\text{ V}$	$V_{OH} - 0.15\text{ V}$
$\geq 2.7\text{ V}$	$1.5\text{ V}$	$1.5\text{ V}$	$V_{OL} + 0.3\text{ V}$	$V_{OH} - 0.3\text{ V}$



Test data is given in [Table 9](#).

Definitions test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance includes jig and probe capacitance.

$R_T$  = Termination resistance should be equal to  $Z_0$  of pulse generator.

$V_{EXT}$  = Test voltage for switching times.

**Figure 8. Test circuit for measuring switching times**

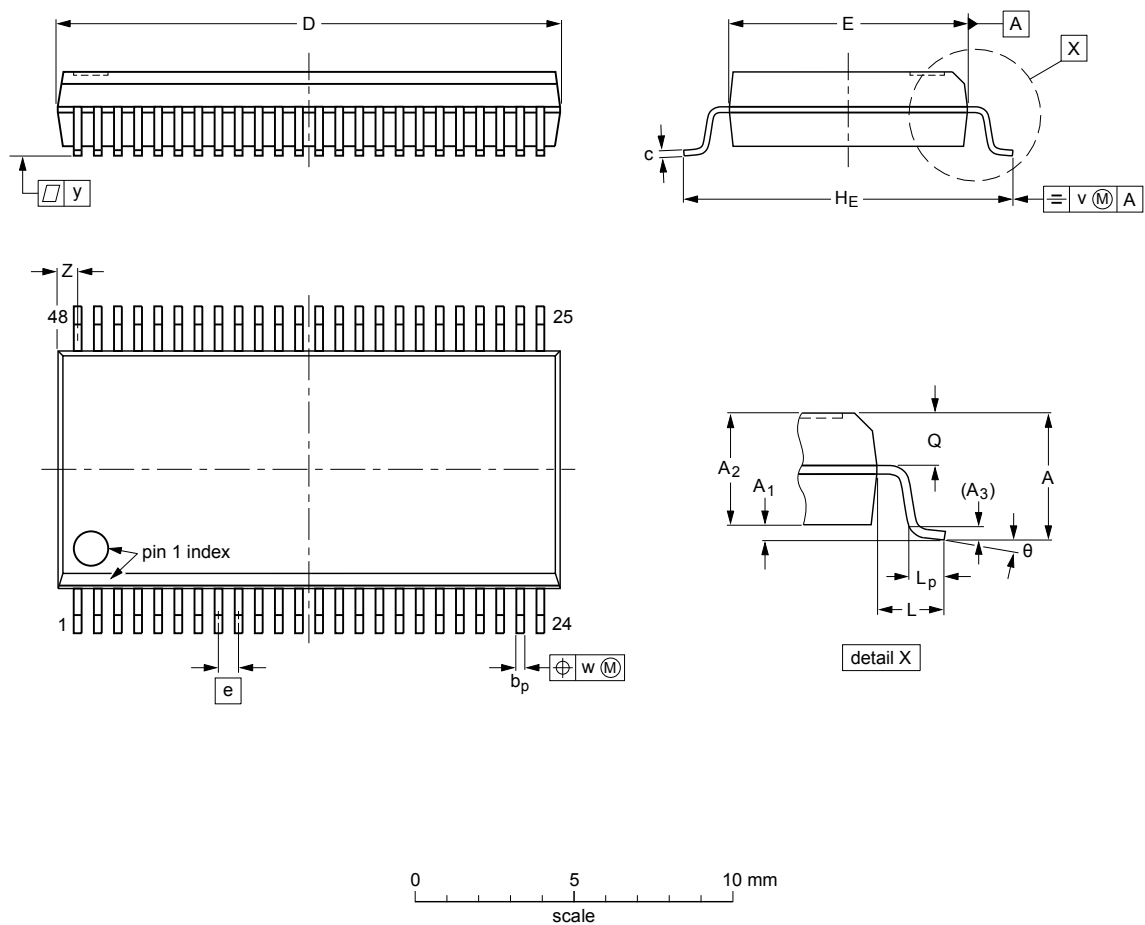
### Table 9. Test data

Supply voltage	Input		Load		V <sub>EXT</sub>		
V <sub>CC</sub>	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>
< 2.7 V	V <sub>CC</sub>	≤2.0 ns	30 pF	500 Ω	open	GND	2 × V <sub>CC</sub>
2.7 V to 3.6 V	2.7 V	≤2.5 ns	50 pF	500 Ω	open	GND	2 × V <sub>CC</sub>

11 Package outline

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



DIMENSIONS (mm are the original dimensions)

UNIT	A <sub>max.</sub>	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	16.00 15.75	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT370-1		MO-118				99-12-27 03-02-19

Figure 9. Package outline SOT370-1 (SSOP48)

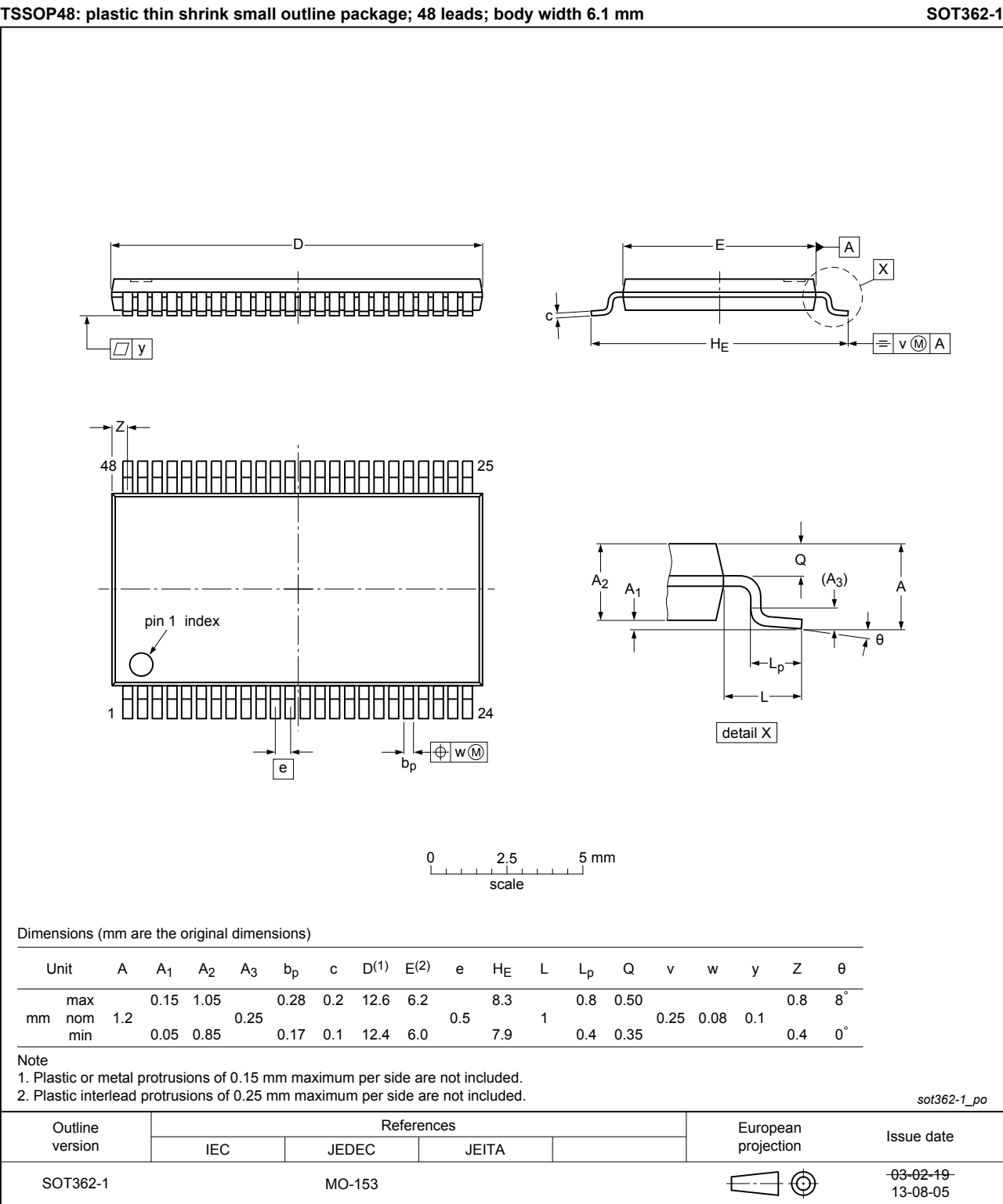


Figure 10. Package outline SOT362-1 (TSSOP48)

## 12 Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

## 13 Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74ALVC_ALVCH16245 v.4	20171121	Product data sheet	-	74ALVC_ALVCH16245 v.3
Modifications:	<ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>			
74ALVC_ALVCH16245 v.3	20040512	Product data sheet	-	74ALVCH16245 v.2
				74ALVC16245_ 74ALVCH16245 v.1
Modifications:	<ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the current presentation and information standard of Philips Semiconductors.</li> <li><a href="#">Section 1</a>: General description updated.</li> </ul>			
74ALVCH16245 v.2	19980629	Product specification	-	74ALVCH16245 v.1
74ALVC16245_ 74ALVCH16245 v.1	19980325	Product specification	-	-
74ALVCH16245 v.1	19950102	Preliminary specification	-	-

## 14 Legal information

### 14.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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